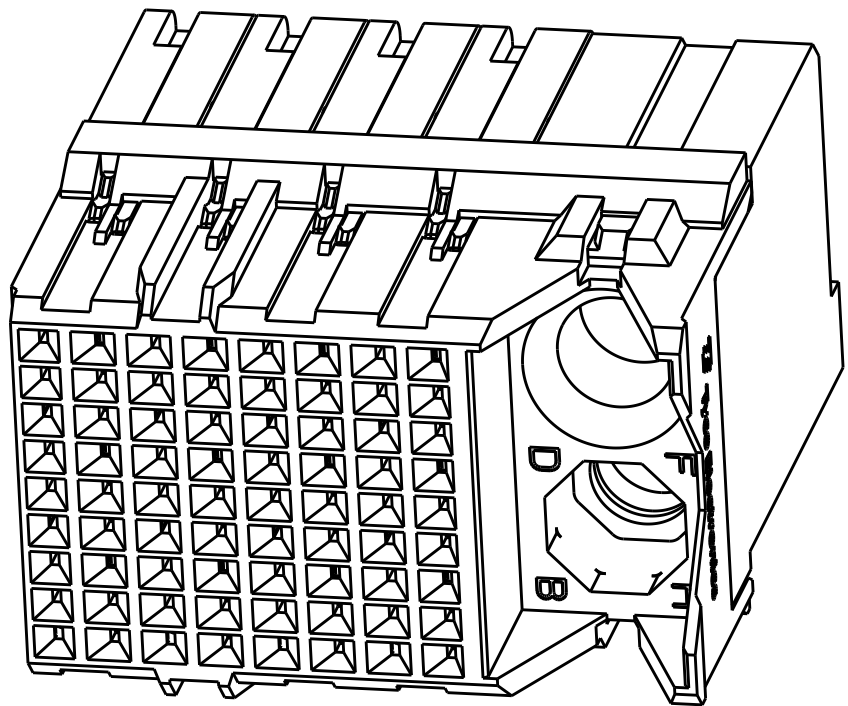


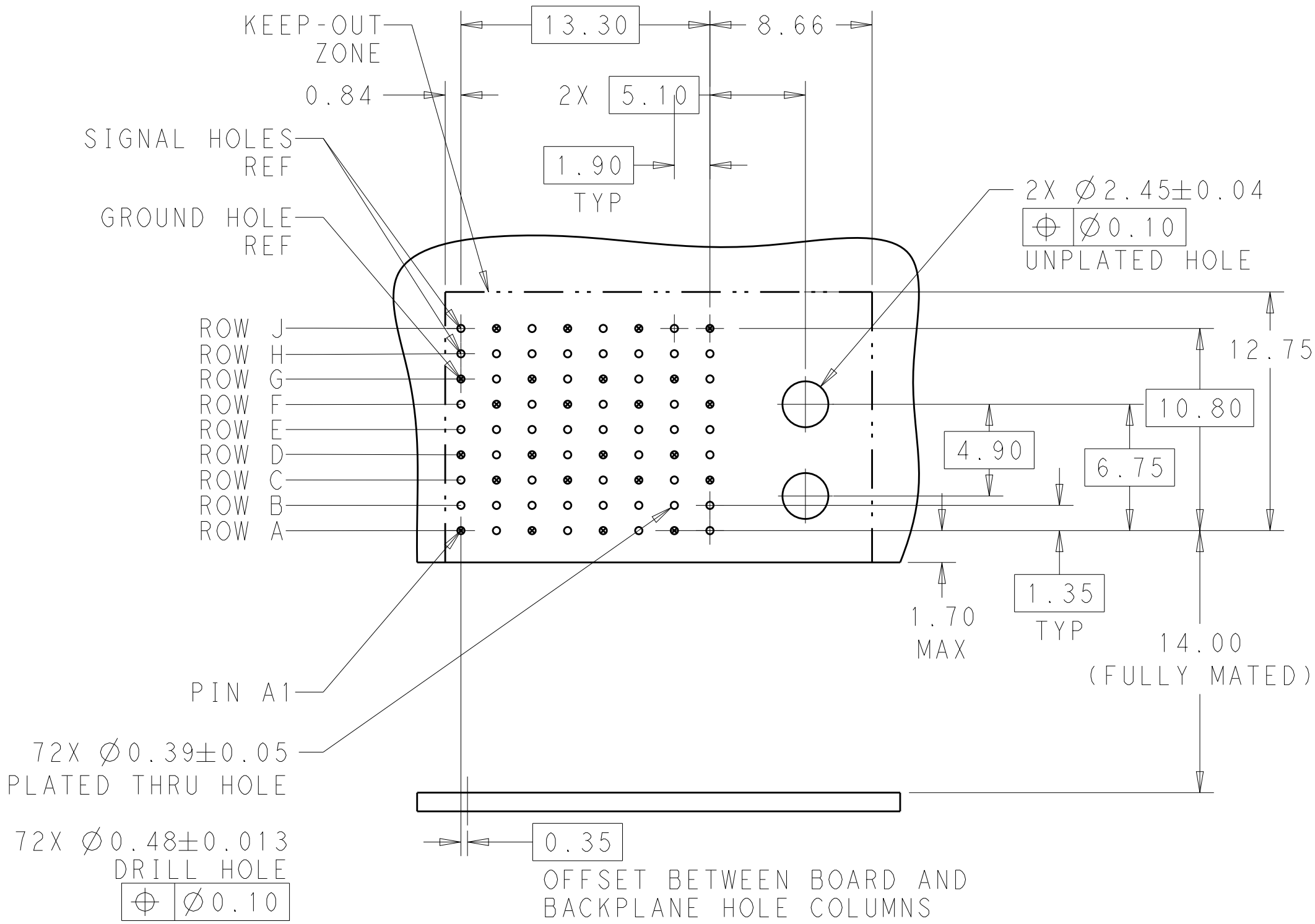
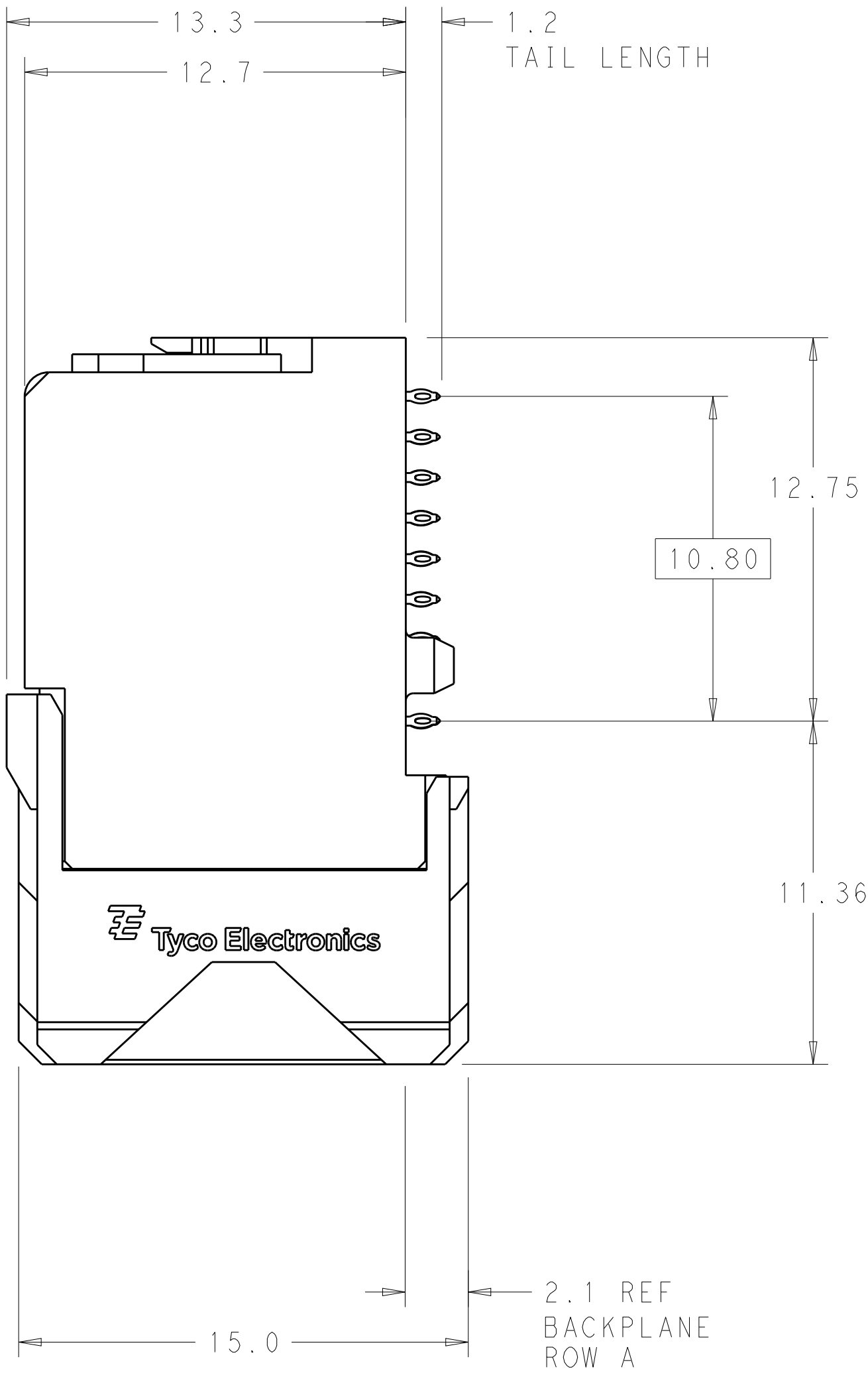
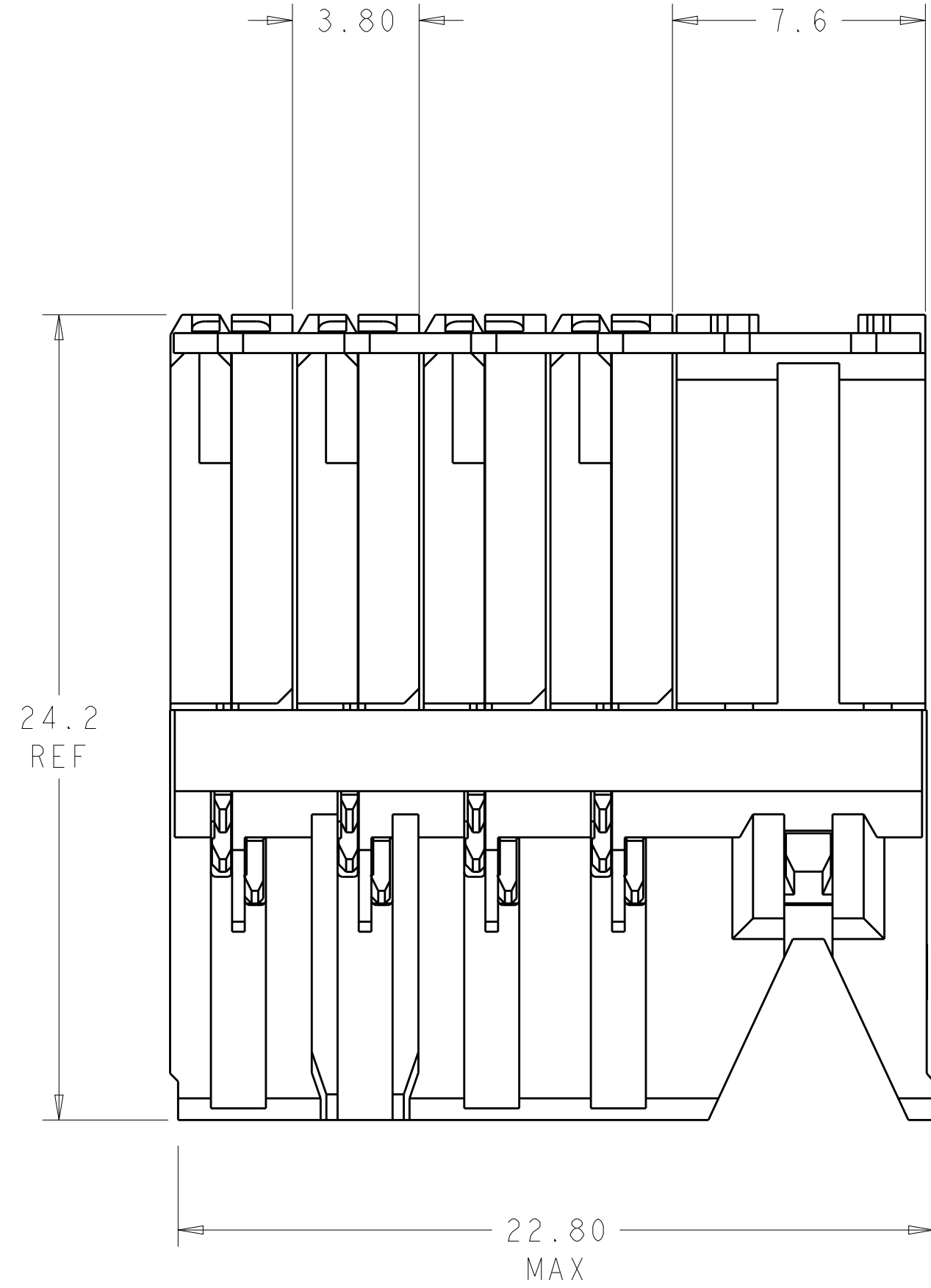
LOC	DIST	REVISIONS					
AD	00	P	LTR	DESCRIPTION	DATE	DWN	APVD
			G1	REVISED PER ECO-14-018035	11MAR2015	AP	DD

- 1 MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- 2 FINISH:
30µ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN
ON PCB TAILS, NICKEL OVERALL.
3. CONNECTORS SUPPLIED WITH MOUNTING SCREW.



SCALE 4:1

REFER TO WWW.TE.COM
FOR PRODUCT AVAILABILITY



RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

KEY POSITION CHART	
	NONE

H	2	8-2057692-1
G	2	7-2057692-1
F	2	6-2057692-1
E	2	5-2057692-1
D	2	4-2057692-1
C	2	3-2057692-1
B	2	2-2057692-1
A	2	1-2057692-1
NONE	2	2057692-1
KEY POSITION		PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN D. HUMBERT 04FEB2011	TE Connectivity
DIMENSIONS:		CHK D. DIXON 04FEB2011	
mm	TOLERANCES UNLESS OTHERWISE SPECIFIED:	APVD D. DIXON 04FEB2011	NAME
	0 PLC ±	PRODUCT SPEC	IMPACT, 3 PAIR, DAUGHTERCARD 8 COLUMN, RIGHT GUIDED, SIGNAL MODULE, 0.39 EYELET
	1 PLC ±0.2	APPLICATION SPEC	
	2 PLC ±0.13	WEIGHT	
	3 PLC ±	CUSTOMER DRAWING	
	4 PLC ±	SCALE 6:1	SHEET 1 OF 1
MATERIAL	FINISH SEE TABLE	RESTRICTED TO	REV G1